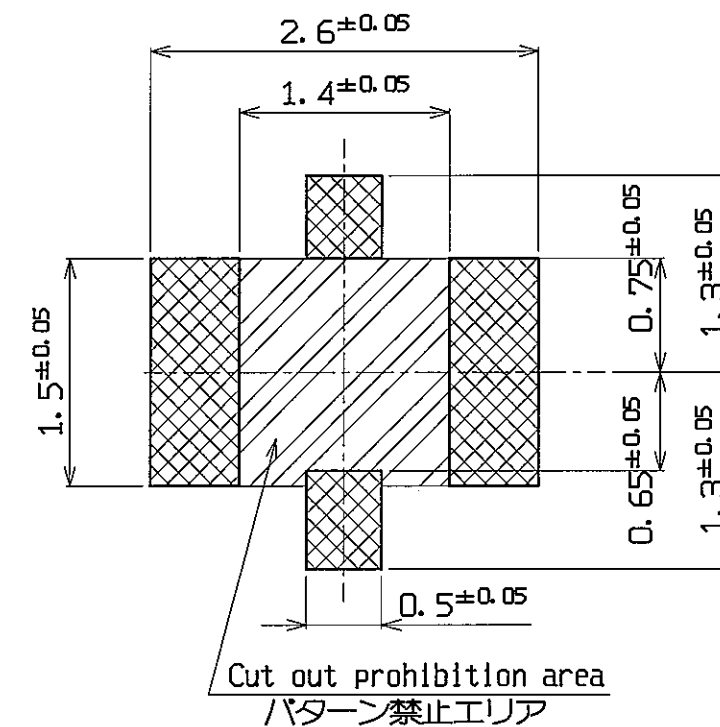
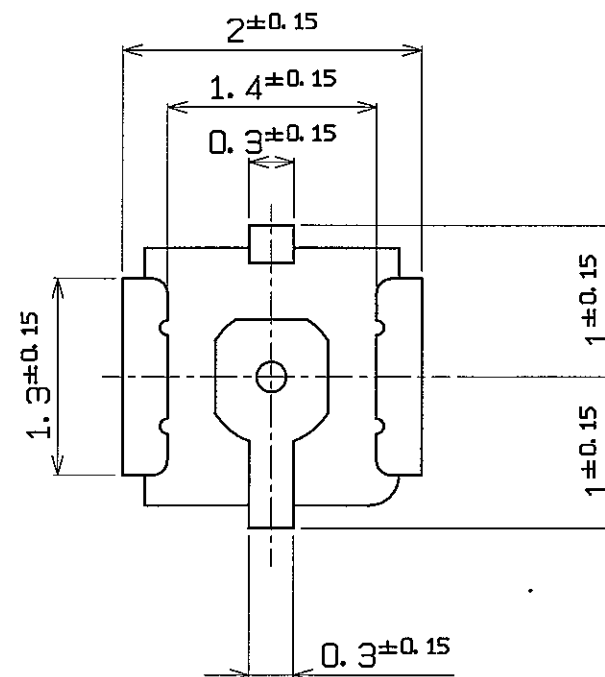
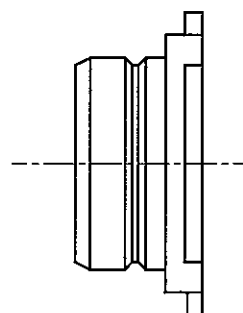
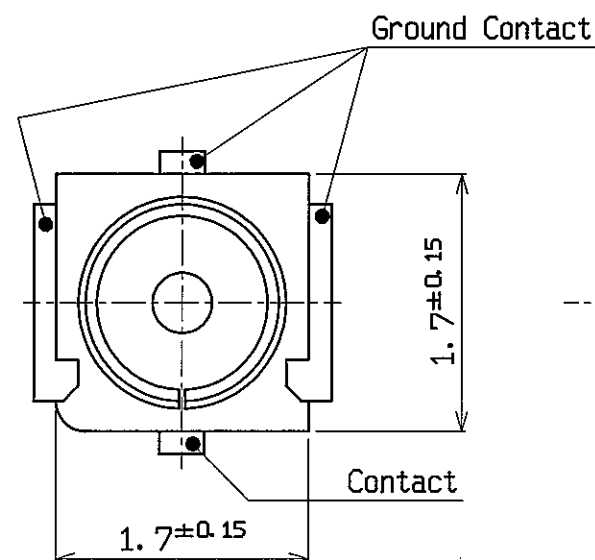
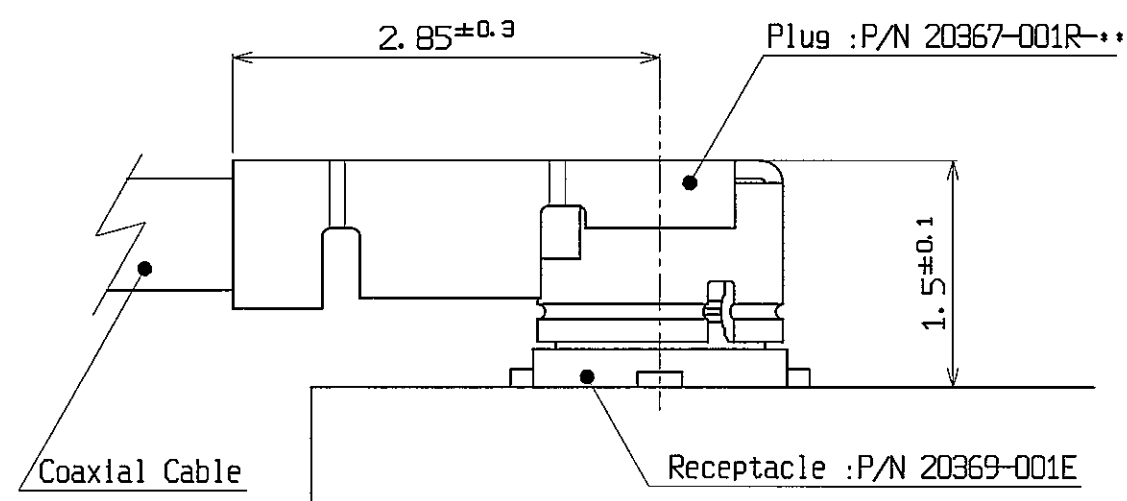
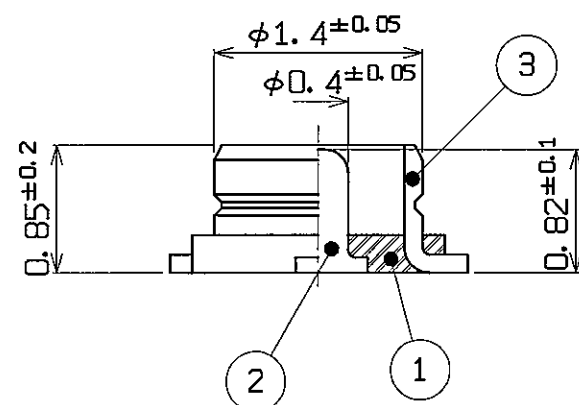


PART NO.
20369-001E



RECOMMENDED FOOTPRINT PATTERN



注記

1. MATERIAL

- ① HOUSING : LCP (GF=30%) BLACK UL94V-0
② CONTACT : BRASS Au 0.05μm MIN. OVER Ni 1.27μm MIN.
③ GROUND CONTACT : PHOSPHOR BRONZE Au 0.03μm MIN. OVER Ni 1.27μm MIN.
2. COPLANARITY : 0.10mm MAX.
3. PACKING : EMBOSS TAPE

GENERAL TOLERANCE	
6 MAX.	±0.2
6 OVER MAX. 30	±0.3
30 OVER MAX. 120	±0.5
ANGLE	±2°

MATING

3	205306	Y. H	JUL/01/05	T. H	DESIGN'D BY	DATE	I-PEX Interconnect and Packaging Electronics TOKYO, JAPAN			
2	205231	TOM	MAY/16/05	T. H	CHK'D BY	DATE				
1	205025	TOM	JAN/20/05	T. H	T. HARADA	Mar./02/04	TITLE			
0	204066	TOM	MAR/01/04		APP'D BY	DATE				
REV	ECN	BY	DATE	APP	K. KATABUCHI	Mar./02/04	MHF III Connector Receptacle			
REV. RECORD					CUSTOMER COPY	PROJECTION	SCALE	UNIT	DWG. No.	SHEET
SERIES No.						20/1	mm		20369	1/1
										REV. 3